

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT7695797

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HAO-JAN MOU	12/13/2021
CHING-SUNG LIN	11/25/2021
CHIN-CHUAN WU	11/25/2021
CHIH-KAI CHEN	11/25/2021
YUNG-LUNG HAN	11/18/2021
CHI-FENG HUANG	11/18/2021
WEI-MING LEE	11/19/2021
RECEIVING PARTY DATA	
Name:	MICROJET TECHNOLOGY CO., LTD.
Street Address:	1F., NO.28, R&D 2ND RD., SCIENCE-BASED INDUSTRIAL PARK
City:	HSINCHU CITY
State/Country:	TAIWAN
Postal Code:	30076
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17083599
CORRESPONDENCE DATA	
Fax Number:	(404)521-4286
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	678-483-8899
Email:	dan.mcclure@mqlaw.com
Correspondent Name:	MCCLURE, QUALEY & RODACK LLP
Address Line 1:	280 INTERSTATE NORTH CIRCLE
Address Line 2:	SUITE 550
Address Line 4:	ATLANTA, GEORGIA 30339
ATTORNEY DOCKET NUMBER:	251374-1110
NAME OF SUBMITTER:	DANIEL R. MCCLUE
SIGNATURE:	/Daniel R. McClure/
DATE SIGNED:	12/15/2022

	This document serves as an Oath/Declaration (37 CFR 1.63).
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Total Attachments: 3

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COMBINED DECLARATION AND ASSIGNMENT

Title of Invention: HEAT-DISSIPATING COMPONENT FOR MOBILE DEVICE

As a below named inventor, I hereby declare that:

This declaration is directed to:

☐ The attached application; or

☒ United States application number or PCT international application number 17/083,599, filed on October 29, 2020.

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

WHEREAS, MICROJET TECHNOLOGY CO., LTD. of IF., No.28, R&D 2nd Rd., Science-Based Industrial Park, Hsinchu City 30076, Taiwan, its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefor in the United States of America and ☐ in any foreign countries.

NOW, THEREFORE, for good and valuable consideration the receipt and sufficiency of which are hereby acknowledged, the undersigned has (have) sold, assigned and transferred, and by these presents does sell, assign and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America, its territories, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America, its territories, dependencies and possessions, and if the box above is designated, in any and all foreign countries; and to any and all divisions, reissues, continuations, conversions and extensions thereof for the full term or terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional, conversion or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division, conversion or reissue thereof or Letter Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America patent(s) or a grant of a valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patents resulting from said application or any continuing, divisional, conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

LEGAL NAME OF FIRST OR SOLE INVENTOR:

Mou, Hao-Jan

Signature: MOU, HAO - JAN Date: 2021, 12, 13

☒ Additional inventors are being named on separately numbered sheets attached hereto.

LEGAL NAME OF ADDITIONAL JOINT INVENTOR, IF ANY:

Lin, Ching-Sung

Signature: Lin, Ching-Sung Date: 2021.11.25

LEGAL NAME OF ADDITIONAL JOINT INVENTOR, IF ANY:

Wu, Chin-Chuan

Signature: Wu, Chin-Chuan Date: 2021.11.25

LEGAL NAME OF ADDITIONAL JOINT INVENTOR, IF ANY:

Chen, Chih-Kai

Signature: Chen, Chih-Kai Date: 2021.11.25

LEGAL NAME OF ADDITIONAL JOINT INVENTOR, IF ANY:

Han, Yung-Lung

Signature: Han, Yung-Lung Date: 2021.11.18

LEGAL NAME OF ADDITIONAL JOINT INVENTOR, IF ANY:

Huang, Chi-Feng

Signature: Huang, Chi-Feng Date: 2021.11.18

LEGAL NAME OF ADDITIONAL JOINT INVENTOR, IF ANY:

Lee, Wei-Ming

Signature: Lee, Wei-Ming Date: 2021.11.18

PATENT